

Data Sheet December 12, 2007 FN6620.0

Dual LDO with Low Noise, Very High PSRR and Low I_O

ISL9000AMRNCP is a high performance dual LDO capable of sourcing 100mA current from each output. It has a low standby current and very high PSRR and is stable with output capacitance of $1\mu F$ to $10\mu F$ with ESR of up to $200m\Omega.$

The device integrates an individual Power-On-Reset (POR) function for each output. The POR delay for VO2 can be externally programmed by connecting a timing capacitor to the CPOR pin. The POR delay for VO1 is internally fixed at approximately 2ms. A reference bypass pin is also provided for connecting a noise filtering capacitor for low noise and high-PSRR applications.

The quiescent current is typically only $42\mu A$ with both LDO's enabled and active. Separate enable pins control each individual LDO output. When both enable pins are low, the device is in shutdown, typically drawing less than $0.1\mu A$.

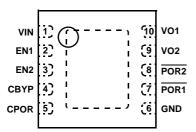
Output voltage for the LDO are VOUT1 = 3.3V and VOUT2 = 1.8V.

Device Information

The specifications for an Enhanced Product (EP) device are defined in a Vendor Item Drawing (VID), which is controlled by the Defense Supply Center in Columbus (DSCC). "Hot-links" to the applicable VID and other supporting application information are provided on our website.

Pinout

(10 LD 3X3 DFN) TOP VIEW



Features

- Integrates Two 100mA High Performance LDO's
- I_{OUT} per Channel is 50mA at T_J = +150°C
- Excellent Transient Response to Large Current Steps
- ±1.8% Accuracy Over all Operating Conditions
- Excellent Load Regulation:
 < 0.1% Voltage Change Across Full Range of Load Current
- Low Output Noise: Typically 30μV_{rms} @ 100μA (1.5V)
- Very High PSRR: 90dB @ 1kHz
- Extremely Low Quiescent Current: 42µA (both LDOs active)
- Wide Input Voltage Capability: 2.3V to 5.5V
- Low Dropout Voltage: Typically 200mV @ 100mA
- Stable with 1µF to 10µF Ceramic Capacitors
- Separate Enable and POR Pins for Each LDO
- Soft-Start and Staged Turn-On to Limit Input Current Surge During Enable
- · Current Limit and Overheat Protection
- Tiny 10 Ld 3x3mm DFN Package
- -55°C to +125°C Operating Temperature Range

Applications

- PDAs, Cell Phones and Smart Phones
- · Portable Instruments, MP3 Players
- · Handheld Devices including Medical Handheld

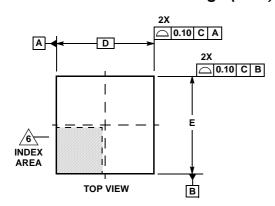
Ordering Information

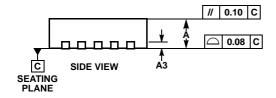
VENDOR PART NUMBER (Notes 1, 2)	VENDOR ITEM DRAWING	PART MARKING	VO1 VOLTAGE (V)	VO2 VOLTAGE (V)	TEMP RANGE (°C)	PACKAGE	PKG DWG. #
ISL9000AMRNCEP	V62/08609-01XB	DKTA	3.3	1.8	-55 to +125	10 Ld 3x3 DFN	L10.3x3C

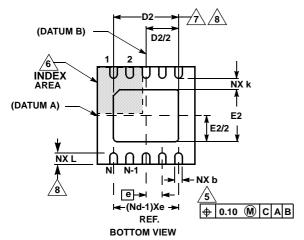
NOTES:

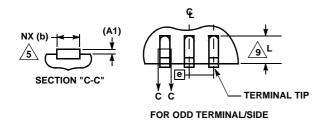
- 1. Add -T to part number for tape and reel.
- 2. Devices must be procured to the VENDOR PART NUMBER.

Dual Flat No-Lead Plastic Package (DFN)









L10.3x3C 10 LEAD DUAL FLAT NO-LEAD PLASTIC PACKAGE

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SYMBOL	MIN	NOMINAL	MAX	NOTES
А	0.85	0.90	0.95	-
A1	-	-	0.05	-
А3		-		
b	0.20	0.25	0.30	5, 8
D		-		
D2	2.33	2.38	2.43	7, 8
E		-		
E2	1.59	1.64	1.69	7, 8
е		-		
k	0.20	-	=	-
L	0.35	0.40	0.45	8
N		2		
Nd		3		

Rev. 1 4/06

NOTES:

- 1. Dimensioning and tolerancing conform to ASME Y14.5-1994.
- 2. N is the number of terminals.
- 3. Nd refers to the number of terminals on D.
- 4. All dimensions are in millimeters. Angles are in degrees.
- 5. Dimension b applies to the metallized terminal and is measured between 0.15mm and 0.30mm from the terminal tip.
- 6. The configuration of the pin #1 identifier is optional, but must be located within the zone indicated. The pin #1 identifier may be either a mold or mark feature.
- 7. Dimensions D2 and E2 are for the exposed pads which provide improved electrical and thermal performance.
- 8. Nominal dimensions are provided to assist with PCB Land Pattern Design efforts, see Intersil Technical Brief TB389.
- 9. COMPLIANT TO JEDEC MO-229-WEED-3 except for dimensions E2 & D2.

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